Product / Process Change Notification



N° 2018-018-A

Dear Customer.

Please find attached our INFINEON Technologies PCN:

Introduction of an additional wafer production and additional wafer test location Infineon Technologies (Kulim) Sdn. Bhd, Kulim, Malaysia for products in B4CD technology in package PG-TO

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 06. May 2019.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0

Chairman of the Supervisory Board: Dr. Eckart Sünner

Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck

Registered Office: Neubiberg Commercial Register

Amtsgericht München HRB 126492

2019-03-25 Page 1 of 2

Product / Process Change Notification



N° 2018-018-A

▶ **Products affected:** Please refer to attached affected product list 1_cip18018_A

Detailed Change Information:

Subject: Introduction of an additional wafer production and additional wafer test

location Infineon Technologies (Kulim) Sdn. Bhd, Kulim, Malaysia for

products in B4CD technology in package PG-TO

Reason: Expansion of wafer production and wafer test to assure continuity of

supply and enable flexible manufacturing.

Description: Old New

wafer production and wafer test location

 Infineon Technologies Austria AG, Villach Infineon Technologies Austria AG, Villach Or

Infineon Technologies (Kulim)Sdn. Bhd, Kulim, Malaysia

▶ **Product Identification:** Wafer lot numbers from Villach start with VExxxxxx

Wafer lot numbers from Kulim with 1Exxxxxx

Kulim and Villach have different SP ordering codes

▶ Impact of Change: No impact on electrical performance. Quality and reliability verified by

qualification. There is no change in form, fit and function.

For automotive products only: DeQuMa-IDs: SEM-PW-13 / SEM-TF-01

► Attachments: 1 cip18018 A affected product list

Time Schedule:

Final qualification report: available

First samples available: on request

Intended start of delivery: 2019-09-23 or earlier after customer approval

If you have any questions, please do not hesitate to contact your local Sales office.

2019-03-25 Page 2 of 2

PCN N° 2018-018-A

Introduction of an additional wafer production and additional wafer test location Infineon Technologies (Kulim) Sdn. Bhd, Kulim, Malaysia for products in B4CD technology in package PG-TO



Sales name	SP number	OPN	Package
TLF80511TC	SP000906390	TLF80511TCATMA1	PG-TO263-3
TLF80511TC	SP001602622	TLF80511TCATMA2	PG-TO263-3
TLF80511TF V33	SP001044146	TLF80511TFV33ATMA1	PG-TO252-3
TLF80511TF V33	SP001602624	TLF80511TFV33ATMA2	PG-TO252-3
TLF80511TF V50	SP001044148	TLF80511TFV50ATMA1	PG-TO252-3
TLF80511TF V50	SP001602626	TLF80511TFV50ATMA2	PG-TO252-3